

Student Poster



Competition

Deadline for Abstract Submission – January 15, 2016 Extended to January 31, 2016

iMAPS New England invites universities and colleges with a strong focus on electronics and packaging to submit poster abstracts for student poster competition. Three cash awards will be given out to students based on technical content, research relevance to the industry and presentation style.

First prize- \$500.00, second prize-\$300.00, third prize-\$100.00

In addition to building significant visibility of participating institutions' research and knowledge, the competition provides an opportunity for close interaction between academic research institutions and industry. The poster showcase on the show floor ensures that the research will be seen by key engineers, managers and executives from all segments of the local and national electronics and packaging industry.

*i*MAPS New England – 43nd Symposium & Expo

May 3, 2016

Holiday Inn – Boxborough Woods Conference Center, Boxborough, Massachusetts The New England Chapter Symposium Technical Program Committee seeks student poster to demonstrate that new technologies and applications that are redefining microelectronics. Areas of interests include but not limited to:

| RF and Microwave – Innovations and | High Temp Electronics Automotive & Consumer Applications Near Hermetic Packaging MEMS Sensors and Nano Technology Printed Electronics Nanoelectronics and Optoelectronics |
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| Emerging Technologies 3D and Beyond High Reliability Interconnects SMT and Electronics Packaging Thermal Management Military and Defense Electronics Medical Device Packaging | Packaging Emerging Technologies |

Symposium Poster Chairs:

Dr. Rita Mohanty, Enthone. CT, <u>rmohanty@enthone.com</u> Dr. Zhiyong Gu, UMASS, Lowel, <u>Zhiyong Gu@uml.edu</u> **Please send abstract to:** <u>rmohanty@enthone.com</u>

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